

Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	MMBTA55	MMBTA56	Unit
Collector-Base Voltage	V_{CBO}	-60	-80	V
Collector-Emitter Voltage	V _{CEO}	-60	-80	V
Emitter-Base Voltage	V _{EBO}	-4.0		V
Collector Current - Continuous	Ic	-500		mA

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)	D	310	mW	
Power Dissipation	(Note 7)	P _D	350		
Thermal Resistance, Junction to Ambient	(Note 6)	D.	403	°C/W	
	(Note 7)	$R_{\theta JA}$	357	C/VV	
Thermal Resistance, Junction to Leads	(Note 8)	$R_{ heta JL}$	350	°C/W	
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C	

ESD Ratings (Note 9)

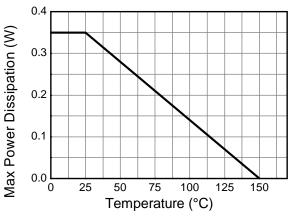
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

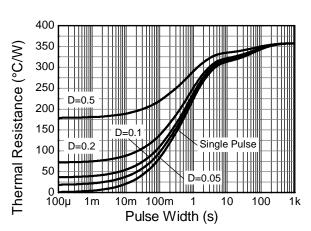
6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

Same as Note 6, except the device is mounted on 15 mm x 15mm 1oz copper.
Thermal resistance from junction to solder-point (at the end of the leads).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.



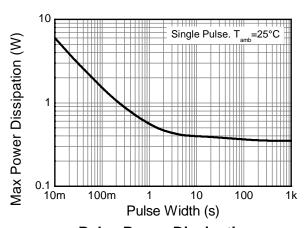
Thermal Characteristics and Derating Information





Derating Curve

Transient Thermal Impedance



Pulse Power Dissipation



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

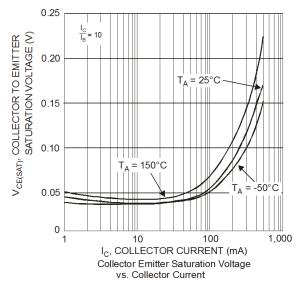
Characteristic		Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 10)						
Collector-Base Breakdown Voltage	MMBTA55 MMBTA56	BV _{CBO}	-60 -80	_	V	$I_C = -100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	MMBTA55 MMBTA56	BV _{CEO}	-60 -80	_	٧	$I_C = -1.0 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage		BV_{EBO}	-5.0	-4.0	_	$I_E = -100\mu A, I_C = 0$
Collector Cut-Off Current	MMBTA55 MMBTA56	I _{CBO}		-100	nA	$V_{CB} = -60V, I_{E} = 0$ $V_{CB} = -80V, I_{E} = 0$
Collector Cut-Off Current		ICEX	_	-100	nA	$V_{CE} = -60V, I_{BO} = 0V$ $V_{CE} = -80V, I_{BO} = 0V$
ON CHARACTERISTICS (Note 10)						
DC Current Gain		h _{FE}	100	_		$I_C = -10$ mA, $V_{CE} = -1.0$ V $I_C = -100$ mA, $V_{CE} = -1.0$ V
Collector-Emitter Saturation Voltage		V _{CE(SAT)}	_	-0.25	V	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$
Base-Emitter Saturation Voltage		V _{BE(SAT)}	_	-1.2	V	I _C = -100mA, V _{CE} = -1.0V
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product		f⊤	50	_	MHz	$V_{CE} = -1.0V, I_{C} = -100mA,$ f = 100MHz

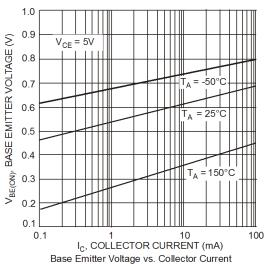
Note:

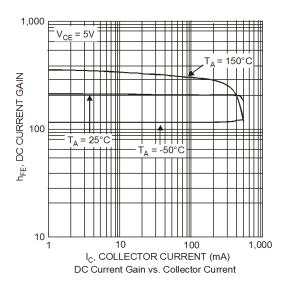
10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

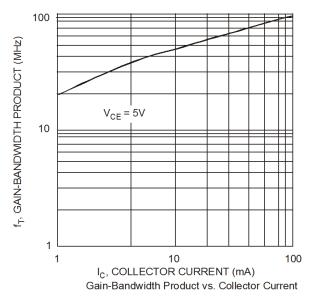


Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





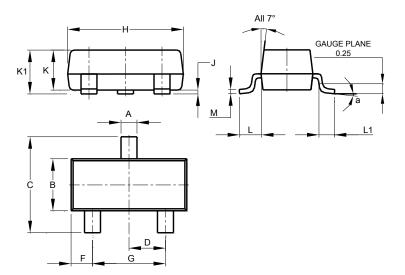






Package Outline Dimensions

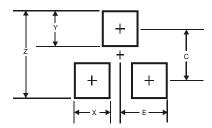
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
7	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	8°				
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
C	2.0
E	1.35



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